## Power MOSFET

| PRODUCT SUMMARY |  |  |
| :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{DS}}(\mathrm{V})$ | -100 |  |
| $\mathrm{R}_{\mathrm{DS}(\mathrm{on})}(\Omega)$ | $\mathrm{V}_{\mathrm{GS}}=-10 \mathrm{~V}$ | 0.20 |
| $\mathrm{Q}_{\mathrm{g}}($ Max. $)(\mathrm{nC})$ | 61 |  |
| $\mathrm{Q}_{\mathrm{gs}}(\mathrm{nC})$ | 14 |  |
| $\mathrm{Q}_{\mathrm{gd}}(\mathrm{nC})$ | 29 |  |
| Configuration | Single |  |



## FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- $175{ }^{\circ} \mathrm{C}$ Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC


## DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.
The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W . The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

## ORDERING INFORMATION

| Package | TO-220AB |
| :--- | :--- |
| Lead $(\mathrm{Pb})$-free | IRF9540PbF |
|  | SiHF9540-E3 |
| SnPb | IRF9540 |
|  | SiHF9540 |


| ABSOLUTE MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$, unless otherwise noted) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| PARAMETER |  |  | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage |  |  | $\mathrm{V}_{\mathrm{DS}}$ | -100 | V |
| Gate-Source Voltage |  |  | $\mathrm{V}_{\mathrm{GS}}$ | $\pm 20$ |  |
| Continuous Drain Current | $\mathrm{V}_{\mathrm{GS}}$ at -10 V | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | ID | -19 | A |
|  |  | $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ |  | -13 |  |
| Pulsed Drain Current ${ }^{\text {a }}$ |  |  | $\mathrm{I}_{\mathrm{DM}}$ | -72 |  |
| Linear Derating Factor |  |  |  | 1.0 | W/ ${ }^{\circ} \mathrm{C}$ |
| Single Pulse Avalanche Energy ${ }^{\text {b }}$ |  |  | $\mathrm{E}_{\text {AS }}$ | 640 | mJ |
| Repetitive Avalanche Current ${ }^{\text {a }}$ |  |  | $\mathrm{I}_{\text {AR }}$ | -19 | A |
| Repetitive Avalanche Energy ${ }^{\text {a }}$ |  |  | $\mathrm{E}_{\text {AR }}$ | 15 | mJ |
| Maximum Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  | $\mathrm{P}_{\mathrm{D}}$ | 150 | W |
| Peak Diode Recovery $\mathrm{dV} / \mathrm{dt}^{\text {c }}$ |  |  | $\mathrm{dV} / \mathrm{dt}$ | -5.5 | $\mathrm{V} / \mathrm{ns}$ |
| Operating Junction and Storage Temperature Range |  |  | $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {stg }}$ | -55 to +175 | ${ }^{\circ} \mathrm{C}$ |
| Soldering Recommendations (Peak Temperature) | for 10 s |  |  | $300{ }^{\text {d }}$ |  |
| Mounting Torque | 6-32 or M3 screw |  |  | 10 | $\mathrm{lbf} \cdot \mathrm{in}$ |
|  |  |  |  | 1.1 | $\mathrm{N} \cdot \mathrm{m}$ |

## Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. $\mathrm{V}_{\mathrm{DD}}=-25 \mathrm{~V}$, starting $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}, \mathrm{L}=2.7 \mathrm{mH}, \mathrm{R}_{\mathrm{g}}=25 \Omega, \mathrm{I}_{\mathrm{AS}}=-19 \mathrm{~A}$ (see fig. 12).
c. $\mathrm{I}_{\mathrm{SD}} \leq-19 \mathrm{~A}, \mathrm{dl} / \mathrm{dt} \leq 200 \mathrm{~A} / \mu \mathrm{s}, \mathrm{V}_{\mathrm{DD}} \leq \mathrm{V}_{\mathrm{DS}}, \mathrm{T}_{\mathrm{J}} \leq 175^{\circ} \mathrm{C}$.
d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply


## Vishay Siliconix

| THERMAL RESISTANCE RATINGS |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | $\mathrm{R}_{\mathrm{thJA}}$ | - | 62 |  |
| Case-to-Sink, Flat, Greased Surface | $\mathrm{R}_{\mathrm{thCs}}$ | 0.50 | - |  |
| Maximum Junction-to-Case (Drain) | $\mathrm{R}_{\mathrm{thJc}}$ | - | 1.0 |  |



## Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width $\leq 300 \mu \mathrm{~s}$; duty cycle $\leq 2 \%$.

TYPICAL CHARACTERISTICS $\left(25^{\circ} \mathrm{C}\right.$, unless otherwise noted)


91078_01

- $\mathrm{V}_{\mathrm{DS}}$, Drain-to-Source Voltage (V)

Fig. 1 - Typical Output Characteristics, $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$


91078_02 - V
Fig. 2 - Typical Output Characteristics, $\mathrm{T}_{\mathrm{C}}=175^{\circ} \mathrm{C}$


91078_03

- $\mathrm{V}_{\text {GS }}$, Gate-to-Source Voltage (V)

Fig. 3-Typical Transfer Characteristics


91078_04

Fig. 4 - Normalized On-Resistance vs. Temperature


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage


Fig. 7 - Typical Source-Drain Diode Forward Voltage


91078_08

- $\mathrm{V}_{\mathrm{DS}}$, Drain-to-Source Voltage (V)


Fig. 9 - Maximum Drain Current vs. Case Temperature


Fig. 10a - Switching Time Test Circuit


Fig. 10b - Switching Time Waveforms


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case


Fig. 12a - Unclamped Inductive Test Circuit


Fig. 12b - Unclamped Inductive Waveforms


Fig. 12c - Maximum Avalanche Energy vs. Drain Current


Fig. 13a - Basic Gate Charge Waveform


Fig. 13b - Gate Charge Test Circuit


Fig. 14 - For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91078.

TO-220AB


| DIM. | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN. | MAX. | MIN. | MAX. |
| A | 4.25 | 4.65 | 0.167 | 0.183 |
| b | 0.69 | 1.01 | 0.027 | 0.040 |
| b(1) | 1.20 | 1.73 | 0.047 | 0.068 |
| c | 0.36 | 0.61 | 0.014 | 0.024 |
| D | 14.85 | 15.49 | 0.585 | 0.610 |
| E | 10.04 | 10.51 | 0.395 | 0.414 |
| e | 2.41 | 2.67 | 0.095 | 0.105 |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 |
| F | 1.14 | 1.40 | 0.045 | 0.055 |
| H(1) | 6.09 | 6.48 | 0.240 | 0.255 |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 |
| L | 13.35 | 14.02 | 0.526 | 0.552 |
| L(1) | 3.32 | 3.82 | 0.131 | 0.150 |
| $\varnothing$ P | 3.54 | 3.94 | 0.139 | 0.155 |
| Q | 2.60 | 3.00 | 0.102 | 0.118 |
| ECN: X10-0416-Rev. M, 01-Nov-10 |  |  |  |  |
| DWG: 5471 |  |  |  |  |

Note

* $\mathrm{M}=1.32 \mathrm{~mm}$ to 1.62 mm (dimension including protrusion) Heatsink hole for HVM


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